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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	64MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, HLVD, POR, PWM, WDT
Number of I/O	24
Program Memory Size	8KB (4K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 19x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SSOP (0.209", 5.30mm Width)
Supplier Device Package	28-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18lf23k22-i-ss

FIGURE 3: 40-PIN PDIP DIAGRAM

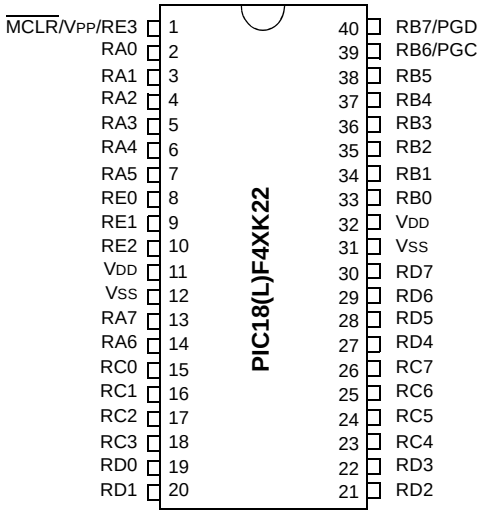
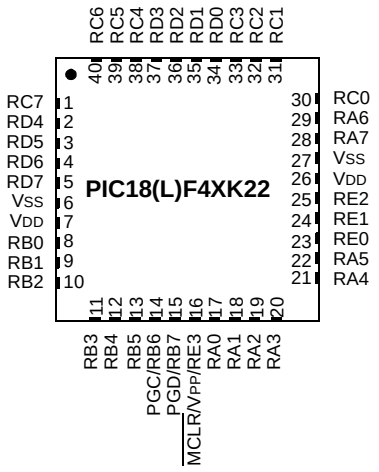


FIGURE 4: 40-PIN UQFN DIAGRAM



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REGISTER 2-2: OSCCON2: OSCILLATOR CONTROL REGISTER 2

R-0/0	R-0/q	U-0	R/W-0/0	R/W-0/u	R/W-1/1	R-x/u	R-0/0
PLLRDY	SOSCRUN	—	MFIOSEL	SOSCGO(1)	PRISD	MFIOFS	LFIOFS
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	q = depends on condition
'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	
-n/n = Value at POR and BOR/Value at all other Resets			

bit 7 **PLLRDY:** PLL Run Status bit
1 = System clock comes from 4xPLL
0 = System clock comes from an oscillator, other than 4xPLL

bit 6 **SOSCRUN:** SOSC Run Status bit
1 = System clock comes from secondary SOSC
0 = System clock comes from an oscillator, other than SOSC

bit 5 **Unimplemented:** Read as '0'.

bit 4 **MFIOSEL:** MFINTOSC Select bit
1 = MFINTOSC is used in place of HFINTOSC frequencies of 500 kHz, 250 kHz and 31.25 kHz
0 = MFINTOSC is not used

bit 3 **SOSCGO(1):** Secondary Oscillator Start Control bit
1 = Secondary oscillator is enabled.
0 = Secondary oscillator is shut off if no other sources are requesting it.

bit 2 **PRISD:** Primary Oscillator Drive Circuit Shutdown bit
1 = Oscillator drive circuit on
0 = Oscillator drive circuit off (zero power)

bit 1 **MFIOFS:** MFINTOSC Frequency Stable bit
1 = MFINTOSC is stable
0 = MFINTOSC is not stable

bit 0 **LFIOFS:** LFINTOSC Frequency Stable bit
1 = LFINTOSC is stable
0 = LFINTOSC is not stable

Note 1: The SOSCGO bit is only reset on a POR Reset.

5.1.2.3 PUSH and POP Instructions

Since the Top-of-Stack is readable and writable, the ability to push values onto the stack and pull values off the stack without disturbing normal program execution is a desirable feature. The PIC18 instruction set includes two instructions, PUSH and POP, that permit the TOS to be manipulated under software control. TOSU, TOSH and TOSL can be modified to place data or a return address on the stack.

The PUSH instruction places the current PC value onto the stack. This increments the Stack Pointer and loads the current PC value onto the stack.

The POP instruction discards the current TOS by decrementing the Stack Pointer. The previous value pushed onto the stack then becomes the TOS value.

5.2 Register Definitions: Stack Pointer

REGISTER 5-1: STKPTR: STACK POINTER REGISTER

R/C-0	R/C-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
STKFUL(1)	STKUNF(1)	—	STKPTR<4:0>				
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	C = Clearable only bit
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7 **STKFUL:** Stack Full Flag bit(1)
1 = Stack became full or overflowed
0 = Stack has not become full or overflowed

bit 6 **STKUNF:** Stack Underflow Flag bit(1)
1 = Stack Underflow occurred
0 = Stack Underflow did not occur

bit 5 **Unimplemented:** Read as ‘0’

bit 4-0 **STKPTR<4:0>:** Stack Pointer Location bits

Note 1: Bit 7 and bit 6 are cleared by user software or by a POR.

5.2.0.1 Stack Full and Underflow Resets

Device Resets on Stack Overflow and Stack Underflow conditions are enabled by setting the STVREN bit in Configuration Register 4L. When STVREN is set, a full or underflow will set the appropriate STKFUL or STKUNF bit and then cause a device Reset. When STVREN is cleared, a full or underflow condition will set the appropriate STKFUL or STKUNF bit but not cause a device Reset. The STKFUL or STKUNF bits are cleared by the user software or a Power-on Reset.

5.2.1 FAST REGISTER STACK

A fast register stack is provided for the Status, WREG and BSR registers, to provide a “fast return” option for interrupts. The stack for each register is only one level deep and is neither readable nor writable. It is loaded with the current value of the corresponding register when the processor vectors for an interrupt. All interrupt sources will push values into the stack registers. The values in the registers are then loaded back into their associated registers if the RETFIE,FAST instruction is used to return from the interrupt.

If both low and high priority interrupts are enabled, the stack registers cannot be used reliably to return from low priority interrupts. If a high priority interrupt occurs while servicing a low priority interrupt, the stack register values stored by the low priority interrupt will be overwritten. In these cases, users must save the key registers by software during a low priority interrupt.

If interrupt priority is not used, all interrupts may use the fast register stack for returns from interrupt. If no interrupts are used, the fast register stack can be used to restore the Status, WREG and BSR registers at the end of a subroutine call. To use the fast register stack for a subroutine call, a CALL label, FAST instruction must be executed to save the Status, WREG and BSR registers to the fast register stack. A RETURN, FAST instruction is then executed to restore these registers from the fast register stack.

Example 5-1 shows a source code example that uses the fast register stack during a subroutine call and return.

REGISTER 9-7: PIR4: PERIPHERAL INTERRUPT (FLAG) REGISTER 4

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
—	—	—	—	—	CCP5IF	CCP4IF	CCP3IF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-3 **Unimplemented:** Read as '0'

bit 2 **CCP5IF:** CCP5 Interrupt Flag bits

Capture mode:
1 = A TMR register capture occurred (must be cleared in software)
0 = No TMR register capture occurred

Compare mode:
1 = A TMR register compare match occurred (must be cleared in software)
0 = No TMR register compare match occurred

PWM mode:
Unused in PWM mode.

bit 1 **CCP4IF:** CCP4 Interrupt Flag bits

Capture mode:
1 = A TMR register capture occurred (must be cleared in software)
0 = No TMR register capture occurred

Compare mode:
1 = A TMR register compare match occurred (must be cleared in software)
0 = No TMR register compare match occurred

PWM mode:
Unused in PWM mode.

bit 0 **CCP3IF:** ECCP3 Interrupt Flag bits

Capture mode:
1 = A TMR register capture occurred (must be cleared in software)
0 = No TMR register capture occurred

Compare mode:
1 = A TMR register compare match occurred (must be cleared in software)
0 = No TMR register compare match occurred

PWM mode:
Unused in PWM mode.

REGISTER 10-10: LATx: PORTx OUTPUT LATCH REGISTER(1)

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
LATx7	LATx6	LATx5	LATx4	LATx3	LATx2	LATx1	LATx0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 **LATx<7:0>:** PORTx Output Latch bit value(2)

Note 1: Register Description for LATA, LATB, LATC and LATD.

2: Writes to PORTx are written to corresponding LATx register. Reads from PORTx register is return of I/O pin values.

REGISTER 10-11: LATE: PORTE OUTPUT LATCH REGISTER(1)

U-0	U-0	U-0	U-0	U-0	R/W-x/u	R/W-x/u	R/W-x/u
—	—	—	—	—	LATE2	LATE1	LATE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-3 **Unimplemented:** Read as '0'

bit 2-0 **LATE<2:0>:** PORTE Output Latch bit value(2)

Note 1: Available on PIC18(L)F4XK22 devices only.

2: Writes to PORTE are written to corresponding LATE register. Reads from PORTE register is return of I/O pin values.

REGISTER 10-12: WPUB: WEAK PULL-UP PORTB REGISTER

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
WPUB7	WPUB6	WPUB5	WPUB4	WPUB3	WPUB2	WPUB1	WPUB0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 **WPUB<7:0>:** Weak Pull-up Register bits

1 = Pull-up enabled on PORT pin

0 = Pull-up disabled on PORT pin

12.7.2.3 Comparator C1 Gate Operation

The output resulting from a Comparator 1 operation can be selected as a source for Timer1/3/5 Gate Control. The Comparator 1 output (sync_C1OUT) can be synchronized to the Timer1/3/5 clock or left asynchronous. For more information see **Section 18.8.4 "Synchronizing Comparator Output to Timer1"**.

12.7.2.4 Comparator C2 Gate Operation

The output resulting from a Comparator 2 operation can be selected as a source for Timer1/3/5 Gate Control. The Comparator 2 output (sync_C2OUT) can be synchronized to the Timer1/3/5 clock or left asynchronous. For more information see **Section 18.8.4 "Synchronizing Comparator Output to Timer1"**.

12.7.3 TIMER1/3/5 GATE TOGGLE MODE

When Timer1/3/5 Gate Toggle mode is enabled, it is possible to measure the full-cycle length of a Timer1/3/5 gate signal, as opposed to the duration of a single level pulse.

The Timer1/3/5 Gate source is routed through a flip-flop that changes state on every incrementing edge of the signal. See Figure 12-5 for timing details.

Timer1/3/5 Gate Toggle mode is enabled by setting the TxGTM bit of the TxGCON register. When the TxGTM bit is cleared, the flip-flop is cleared and held clear. This is necessary in order to control which edge is measured.

Note:	Enabling Toggle mode at the same time as changing the gate polarity may result in indeterminate operation.

12.7.4 TIMER1/3/5 GATE SINGLE-PULSE MODE

When Timer1/3/5 Gate Single-Pulse mode is enabled, it is possible to capture a single-pulse gate event. Timer1/3/5 Gate Single-Pulse mode is first enabled by setting the TxGSPM bit in the TxGCON register. Next, the TxGGO/$\overline{\text{DONE}}$ bit in the TxGCON register must be set. The Timer1/3/5 will be fully enabled on the next incrementing edge. On the next trailing edge of the pulse, the TxGGO/$\overline{\text{DONE}}$ bit will automatically be cleared. No other gate events will be allowed to increment Timer1/3/5 until the TxGGO/$\overline{\text{DONE}}$ bit is once again set in software.

Clearing the TxGSPM bit of the TxGCON register will also clear the TxGGO/$\overline{\text{DONE}}$ bit. See Figure 12-6 for timing details.

Enabling the Toggle mode and the Single-Pulse mode simultaneously will permit both sections to work together. This allows the cycle times on the Timer1/3/5 Gate source to be measured. See Figure 12-7 for timing details.

12.7.5 TIMER1/3/5 GATE VALUE STATUS

When Timer1/3/5 Gate Value Status is utilized, it is possible to read the most current level of the gate control value. The value is stored in the TxGVAL bit in the TxGCON register. The TxGVAL bit is valid even when the Timer1/3/5 Gate is not enabled (TMRxGE bit is cleared).

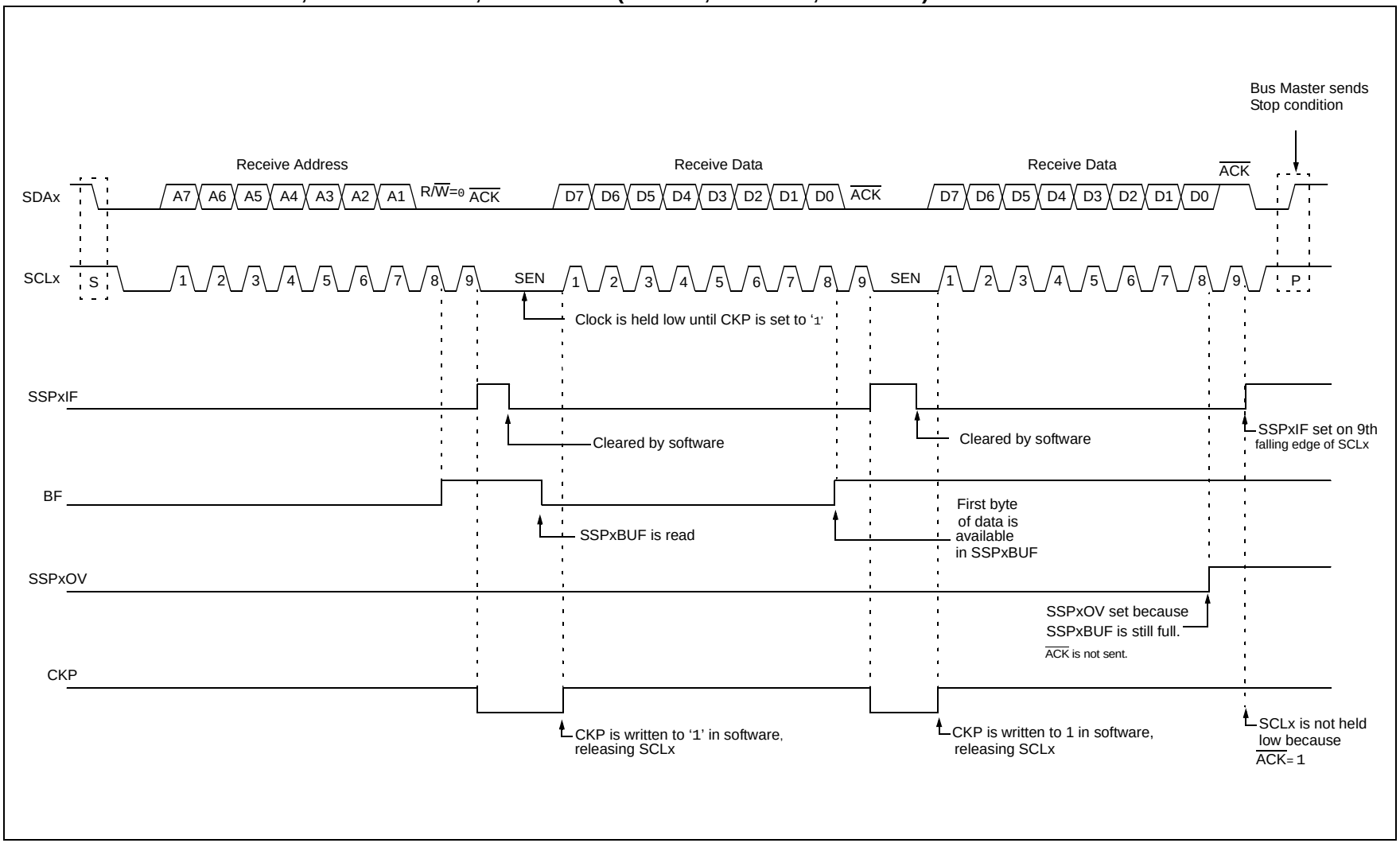
12.7.6 TIMER1/3/5 GATE EVENT INTERRUPT

When Timer1/3/5 Gate Event Interrupt is enabled, it is possible to generate an interrupt upon the completion of a gate event. When the falling edge of TxGVAL occurs, the TMRxGIF flag bit in the PIR3 register will be set. If the TMRxGIE bit in the PIE3 register is set, then an interrupt will be recognized.

The TMRxGIF flag bit operates even when the Timer1/3/5 Gate is not enabled (TMRxGE bit is cleared).

For more information on selecting high or low priority status for the Timer1/3/5 Gate Event Interrupt see **Section 9.0 "Interrupts"**.

FIGURE 15-15: I^2C SLAVE, 7-BIT ADDRESS, RECEPTION (SEN = 1, AHEN = 0, DHEN = 0)



16.3 Register Definitions: EUSART Control

REGISTER 16-1: TxSTAx: TRANSMIT STATUS AND CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-1	R/W-0
CSRC	TX9	TXEN(1)	SYNC	SENDB	BRGH	TRMT	TX9D
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **CSRC:** Clock Source Select bit
Asynchronous mode:
Don't care
Synchronous mode:
1 = Master mode (clock generated internally from BRG)
0 = Slave mode (clock from external source)

bit 6 **TX9:** 9-bit Transmit Enable bit
1 = Selects 9-bit transmission
0 = Selects 8-bit transmission

bit 5 **TXEN:** Transmit Enable bit(1)
1 = Transmit enabled
0 = Transmit disabled

bit 4 **SYNC:** EUSART Mode Select bit
1 = Synchronous mode
0 = Asynchronous mode

bit 3 **SENDB:** Send Break Character bit
Asynchronous mode:
1 = Send Sync Break on next transmission (cleared by hardware upon completion)
0 = Sync Break transmission completed
Synchronous mode:
Don't care

bit 2 **BRGH:** High Baud Rate Select bit
Asynchronous mode:
1 = High speed
0 = Low speed
Synchronous mode:
Unused in this mode

bit 1 **TRMT:** Transmit Shift Register Status bit
1 = TSR empty
0 = TSR full

bit 0 **TX9D:** Ninth bit of Transmit Data
Can be address/data bit or a parity bit.

Note 1: SREN/CREN overrides TXEN in Sync mode.

17.3 Register Definitions: ADC Control

Note:	Analog pin control is determined by the ANSELx registers (see Register 10-2)

REGISTER 17-1: ADCON0: A/D CONTROL REGISTER 0

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	CHS<4:0>					GO/$\overline{\text{DONE}}$	ADON
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7 **Unimplemented:** Read as ‘0’

bit 6-2 **CHS<4:0>: Analog Channel Select bits**
00000 = AN0
00001 = AN1
00010 = AN2
00011 = AN3
00100 = AN4
00101 = AN5**(1)**
00110 = AN6**(1)**
00111 = AN7**(1)**
01000 = AN8
01001 = AN9
01010 = AN10
01011 = AN11
01100 = AN12
01101 = AN13
01110 = AN14
01111 = AN15
10000 = AN16
10001 = AN17
10010 = AN18
10011 = AN19
10100 = AN20**(1)**
10101 = AN21**(1)**
10110 = AN22**(1)**
10111 = AN23**(1)**
11000 = AN24**(1)**
11001 = AN25**(1)**
11010 = AN26**(1)**
11011 = AN27**(1)**
11100 = Reserved
11101 = CTMU
11110 = DAC
11111 = FVR BUF2 (1.024V/2.048V/2.096V Volt Fixed Voltage Reference)**(2)**

bit 1 **GO/$\overline{\text{DONE}}$:** A/D Conversion Status bit
1 = A/D conversion cycle in progress. Setting this bit starts an A/D conversion cycle.
This bit is automatically cleared by hardware when the A/D conversion has completed.
0 = A/D conversion completed/not in progress

bit 0 **ADON:** ADC Enable bit
1 = ADC is enabled
0 = ADC is disabled and consumes no operating current

Note 1: Available on PIC18(L)F4XK22 devices only.
2: Allow greater than 15 μs acquisition time when measuring the Fixed Voltage Reference.

18.0 COMPARATOR MODULE

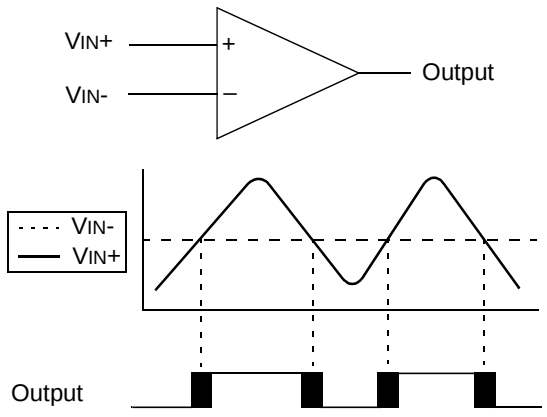
Comparators are used to interface analog circuits to a digital circuit by comparing two analog voltages and providing a digital indication of their relative magnitudes. The comparators are very useful mixed signal building blocks because they provide analog functionality independent of the program execution. The analog comparator module includes the following features:

- Independent comparator control
- Programmable input selection
- Comparator output is available internally/externally
- Programmable output polarity
- Interrupt-on-change
- Wake-up from Sleep
- Programmable Speed/Power optimization
- PWM shutdown
- Programmable and fixed voltage reference
- Selectable Hysteresis

18.1 Comparator Overview

A single comparator is shown in Figure 18-1 along with the relationship between the analog input levels and the digital output. When the analog voltage at VIN+ is less than the analog voltage at VIN-, the output of the comparator is a digital low level. When the analog voltage at VIN+ is greater than the analog voltage at VIN-, the output of the comparator is a digital high level.

FIGURE 18-1: SINGLE COMPARATOR



Note: The black areas of the output of the comparator represents the uncertainty due to input offsets and response time.

24.5 Program Verification and Code Protection

The overall structure of the code protection on the PIC18 Flash devices differs significantly from other PIC microcontroller devices.

The user program memory is divided into three or five blocks, depending on the device. One of these is a Boot Block of 0.5K or 2K bytes, depending on the device. The remainder of the memory is divided into individual blocks on binary boundaries.

Each of the blocks has three code protection bits associated with them. They are:

- Code-Protect bit (CPn)
- Write-Protect bit (WRTn)
- External Block Table Read bit (EBTRn)

Figure 24-2 shows the program memory organization for 8, 16 and 32-Kbyte devices and the specific code protection bit associated with each block. The actual locations of the bits are summarized in Table 24-5.

FIGURE 24-2: CODE-PROTECTED PROGRAM MEMORY FOR PIC18(L)F2X/4XK22

MEMORY SIZE/DEVICE				Block Code Protection Controlled By:
8 Kbytes (PIC18(L)FX3K22)	16 Kbytes (PIC18(L)FX4K22)	32 Kbytes (PIC18(L)FX5K22)	64 Kbytes (PIC18(L)FX6K22)	
Boot Block (000h-1FFh)	Boot Block (000h-7FFh)	Boot Block (000h-7FFh)	Boot Block (000h-7FFh)	CPB, WRTB, EBTRB
Block 0 (200h-FFFh)	Block 0 (800h-1FFFh)	Block 0 (800h-1FFFh)	Block 0 (800h-3FFFh)	CP0, WRT0, EBTR0
Block 1 (1000h-1FFFh)	Block 1 (2000h-3FFFh)	Block 1 (2000h-3FFFh)	Block 1 (4000h-7FFFh)	CP1, WRT1, EBTR1
Unimplemented Read '0's (2000h-1FFFFFh)	Unimplemented Read '0's (4000h-1FFFFFh)	Block 2 (4000h-5FFFh)	Block 2 (8000h-BFFFh)	CP2, WRT2, EBTR2
		Block 3 (6000h-7FFFh)	Block 3 (C000h-FFFFh)	CP3, WRT3, EBTR3
		Unimplemented Read '0's (8000h-1FFFFFh)	Unimplemented Read '0's (10000h-1FFFFFh)	(Unimplemented Memory Space)

TABLE 24-5: CONFIGURATION REGISTERS ASSOCIATED WITH CODE PROTECTION

File Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
300008h	CONFIG5L	—	—	—	—	CP3(1)	CP2(1)	CP1	CP0
300009h	CONFIG5H	CPD	CPB	—	—	—	—	—	—
30000Ah	CONFIG6L	—	—	—	—	WRT3(1)	WRT2(1)	WRT1	WRT0
30000Bh	CONFIG6H	WRTD	WRTB	WRTC(2)	—	—	—	—	—
30000Ch	CONFIG7L	—	—	—	—	EBTR3(1)	EBTR2(1)	EBTR1	EBTR0
30000Dh	CONFIG7H	—	EBTRB	—	—	—	—	—	—

Legend: Shaded bits are unimplemented.

Note 1: Available on PIC18(L)FX5K22 and PIC18(L)FX6K22 devices only.

2: In user mode, this bit is read-only and cannot be self-programmed.

BRA **Unconditional Branch**

Syntax: BRA n

Operands: $-1024 \leq n \leq 1023$

Operation: $(PC) + 2 + 2n \rightarrow PC$

Status Affected: None

Encoding:

1101	0nnn	nnnn	nnnn

Description: Add the 2's complement number '2n' to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is a 2-cycle instruction.

Words: 1

Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	Write to PC
No operation	No operation	No operation	No operation

Example: HERE BRA Jump

Before Instruction
PC = address (HERE)
After Instruction
PC = address (Jump)

BSF **Bit Set f**

Syntax: BSF f, b {,a}

Operands: $0 \leq f \leq 255$
$0 \leq b \leq 7$
$a \in [0,1]$

Operation: $1 \rightarrow f<b>$

Status Affected: None

Encoding:

1000	bbba	ffff	ffff

Description: Bit 'b' in register 'f' is set.
If 'a' is '0', the Access Bank is selected.
If 'a' is '1', the BSR is used to select the GPR bank.
If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \leq 95$ (5Fh). See **Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode"** for details.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write register 'f'

Example: BSF FLAG_REG, 7, 1

Before Instruction
FLAG_REG = 0Ah
After Instruction
FLAG_REG = 8Ah

27.4 DC Characteristics: RC Idle Supply Current, PIC18(L)F2X/4XK22

PIC18LF2X/4XK22		Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +125°C					
PIC18F2X/4XK22		**Standard Operating Conditions (unless otherwise stated)** Operating temperature -40°C ≤ TA ≤ +125°C					
Param No.	**Device Characteristics**	**Typ**	**Max**	**Units**	**Conditions**		
D045	Supply Current (IDD)(1),(2)	0.5	18	µA	-40°C	VDD = 1.8V	FOSC = 31 kHz (**RC_IDLE** mode, LFINTOSC source)
		0.6	18	µA	+25°C		
		0.7	—	µA	+60°C		
		0.75	20	µA	+85°C		
		2.3	22	µA	+125°C		
D046		1.1	20	µA	-40°C	VDD = 3.0V	
		1.2	20	µA	+25°C		
		1.3	—	µA	+60°C		
		1.4	22	µA	+85°C		
		3.2	25	µA	+125°C		
D047		17	30	µA	-40°C	VDD = 2.3V	FOSC = 31 kHz (**RC_IDLE** mode, LFINTOSC source)
		13	30	µA	+25°C		
		14	30	µA	+85°C		
		15	45	µA	+125°C		
D048		19	35	µA	-40°C	VDD = 3.0V	
		15	35	µA	+25°C		
		16	35	µA	+85°C		
		17	50	µA	+125°C		
D049		21	40	µA	-40°C	VDD = 5.0V	
		15	40	µA	+25°C		
		16	40	µA	+85°C		
		18	60	µA	+125°C		
D050		0.11	0.20	mA	-40°C to +125°C	VDD = 1.8V	FOSC = 500 kHz (**RC_IDLE** mode, MFINTOSC source)
D051		0.12	0.25	mA	-40°C to +125°C	VDD = 3.0V	
D052		0.14	0.21	mA	-40°C to +125°C	VDD = 2.3V	FOSC = 500 kHz (**RC_IDLE** mode, MFINTOSC source)
D053		0.15	0.25	mA	-40°C to +125°C	VDD = 3.0V	
D054		0.20	0.31	mA	-40°C to +125°C	VDD = 5.0V	

Note 1: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

Test condition: All Peripheral Module Control bits in PMD0, PMD1 and PMD2 set to '1'.

2: The test conditions for all IDD measurements in active operation mode are:

All I/O pins set as outputs driven to Vss;

$\overline{MCLR}$ = VDD;

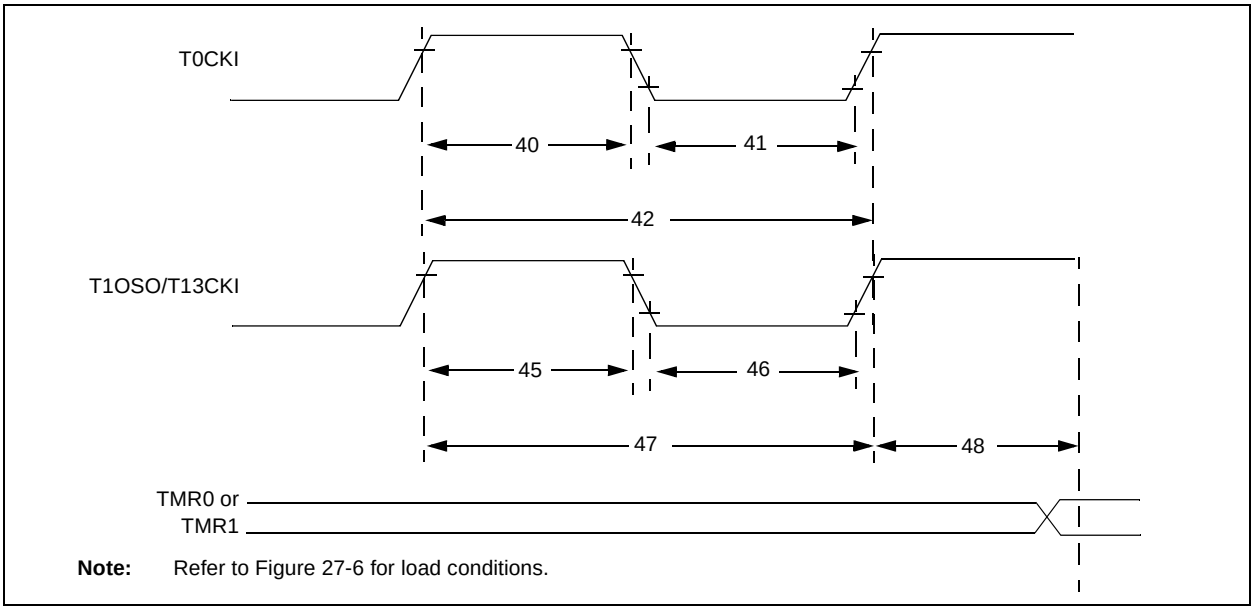
OSC1 = external square wave, from rail-to-rail (PRI_RUN and PRI_IDLE only).

TABLE 27-11: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER AND BROWN-OUT RESET REQUIREMENTS

Param. No.	Symbol	Characteristic	Min	Typ	Max	Units	Conditions
30	TmcL	$\overline{MCLR}$ Pulse Width (low)	2	—	—	µs	
31	TWDT	Watchdog Timer Time-out Period (no postscaler)	3.5	4.1	4.7	ms	1:1 prescaler
32	TOST	Oscillation Start-up Timer Period	1024 TOSC	—	1024 TOSC	—	TOSC = OSC1 period
33	TPWRT	Power-up Timer Period	54.8	64.4	74.1	ms	
34	TIOZ	I/O High-Impedance from $\overline{MCLR}$ Low or Watchdog Timer Reset	—	2	—	µs	
35	TBOR	Brown-out Reset Pulse Width	200[1]	—	—	µs	VDD ≤ BVDD (see D005)
36	TIVRST	Internal Reference Voltage Stable	—	25	35	µs	
37	THLVD	High/Low-Voltage Detect Pulse Width	200[1]	—	—	µs	VDD ≤ VHLVD
38	TCSD	CPU Start-up Time	5	—	10	µs	
39	TIOBST	Time for HF-INTOSC to Stabilize	—	0.25	1	ms	
40	TIOSC_ST	Time for HF-INTOSC to Start	—	TBD	TBD	µs	

Note 1: Minimum pulse width that will consistently trigger a reset or interrupt. Shorter pulses may intermittently trigger a response.

FIGURE 27-11: TIMER0 AND TIMER1 EXTERNAL CLOCK TIMINGS



Note: Refer to Figure 27-6 for load conditions.

FIGURE 28-20: PIC18LF2X/4XK22 TYPICAL IDD: RC_RUN LF-INTOSC 31 kHz

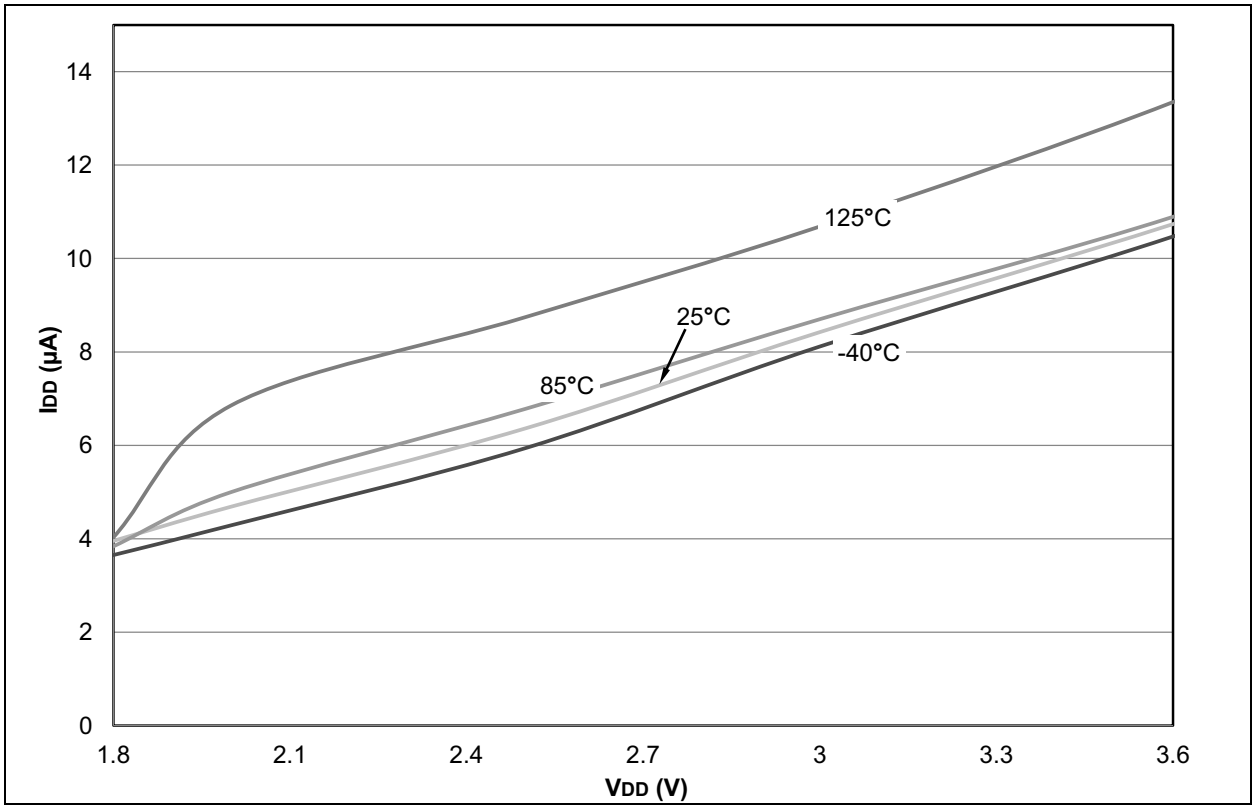


FIGURE 28-21: PIC18LF2X/4XK22 MAXIMUM IDD: RC_RUN LF-INTOSC 31 kHz

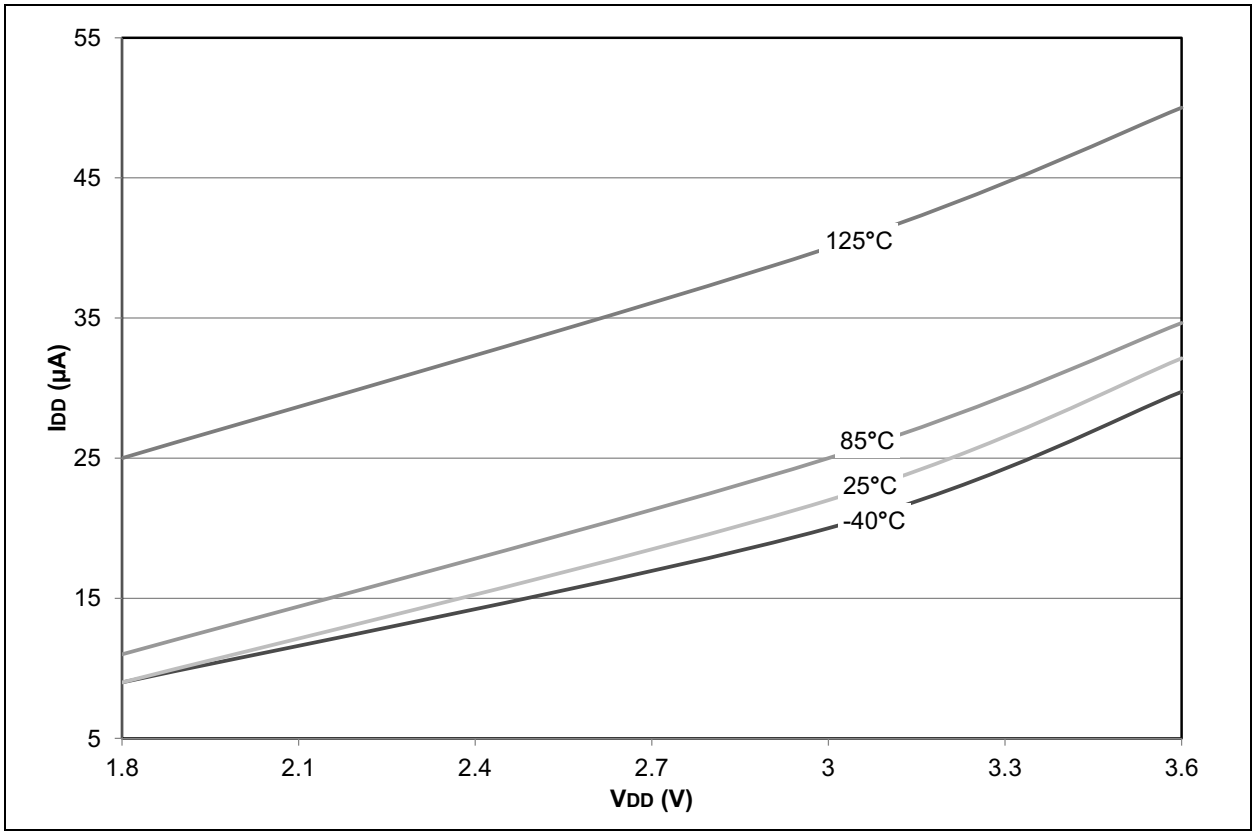


FIGURE 28-96: PIC18(L)F2X/4XK22 TYPICAL FIXED VOLTAGE REFERENCE 2x OUTPUT

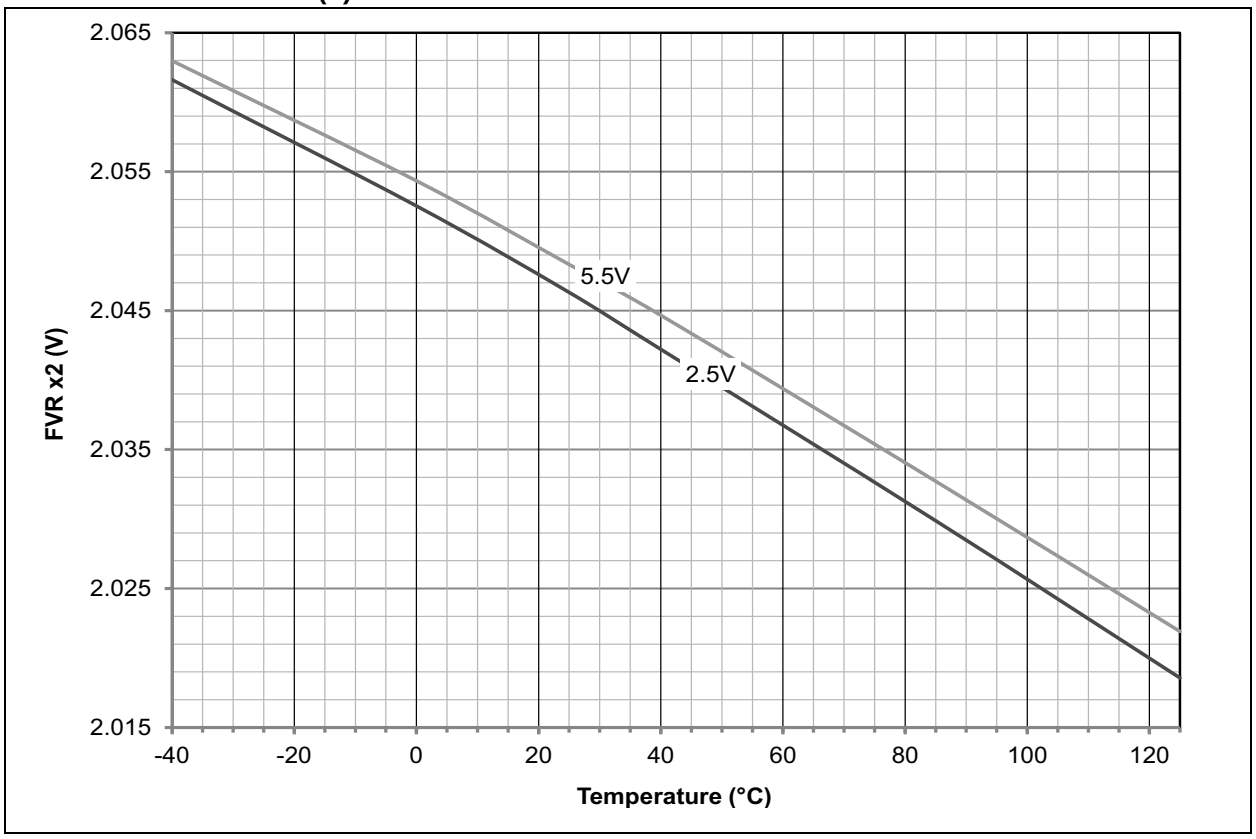
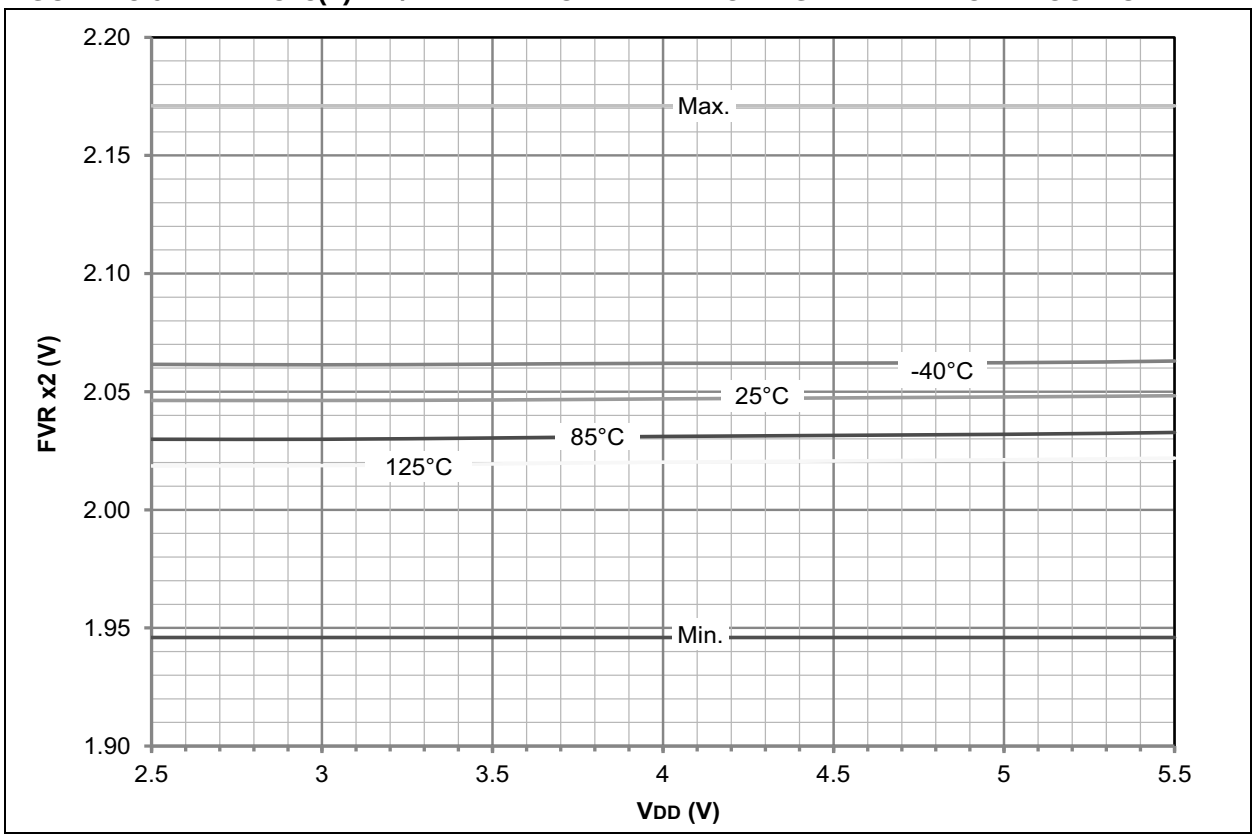
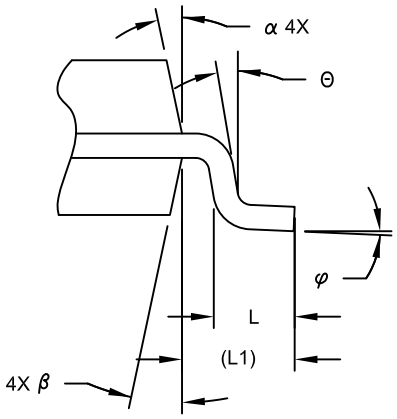


FIGURE 28-97: PIC18(L)F2X/4XK22 TYPICAL FIXED VOLTAGE REFERENCE 2x OUTPUT

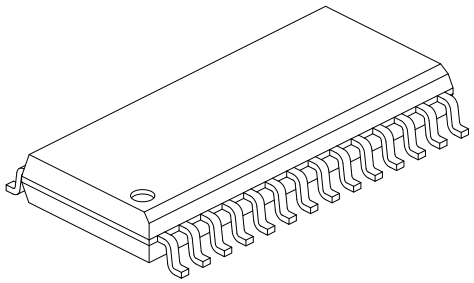


28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



VIEW C



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		28	
Pitch	e		1.27 BSC	
Overall Height	A	-	-	2.65
Molded Package Thickness	A2	2.05	-	-
Standoff §	A1	0.10	-	0.30
Overall Width	E		10.30 BSC	
Molded Package Width	E1		7.50 BSC	
Overall Length	D		17.90 BSC	
Chamfer (Optional)	h	0.25	-	0.75
Foot Length	L	0.40	-	1.27
Footprint	L1		1.40 REF	
Lead Angle	Θ	0°	-	-
Foot Angle	φ	0°	-	8°
Lead Thickness	c	0.18	-	0.33
Lead Width	b	0.31	-	0.51
Mold Draft Angle Top	α	5°	-	15°
Mold Draft Angle Bottom	β	5°	-	15°

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. § Significant Characteristic
3. Dimension D does not include mold flash, protrusions or gate burrs, which shall not exceed 0.15 mm per end. Dimension E1 does not include interlead flash or protrusion, which shall not exceed 0.25 mm per side.
4. Dimensioning and tolerancing per ASME Y14.5M

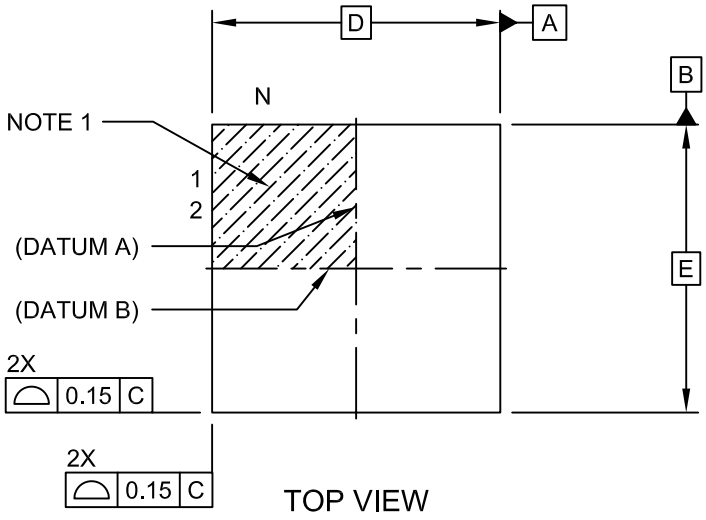
   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

   REF: Reference Dimension, usually without tolerance, for information purposes only.
5. Datums A & B to be determined at Datum H.

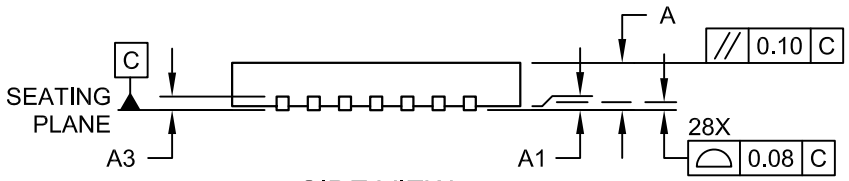
Microchip Technology Drawing C04-052C Sheet 2 of 2

28-Lead Plastic Quad Flat, No Lead Package (ML) - 6x6 mm Body [QFN]
With 0.55 mm Terminal Length

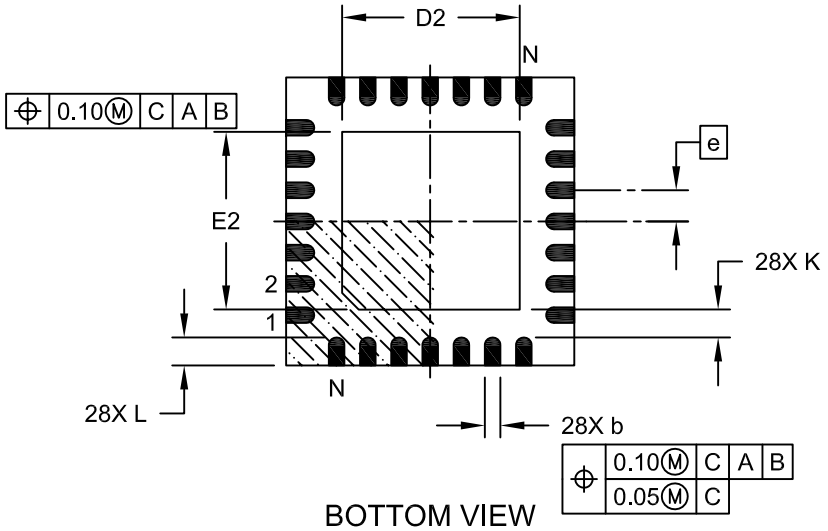
Note:	For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



TOP VIEW



SIDE VIEW

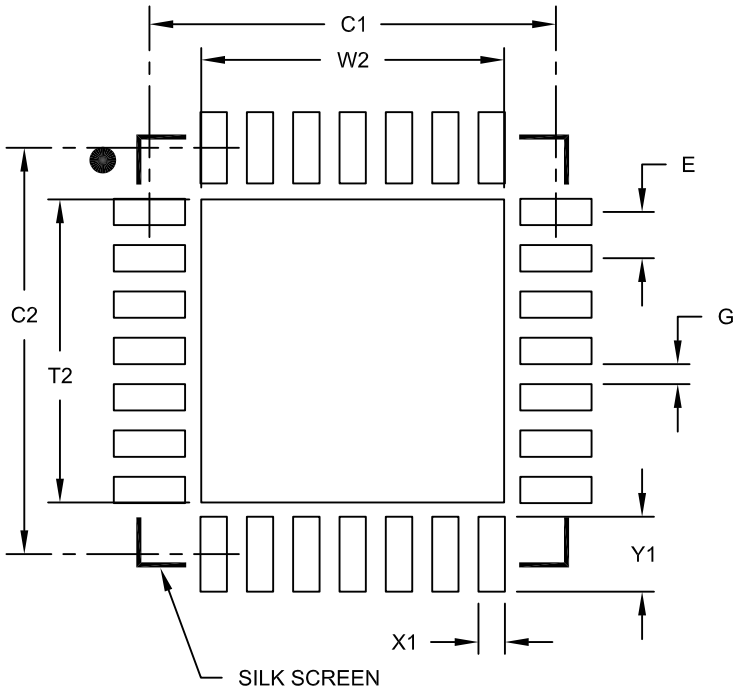


BOTTOM VIEW

Microchip Technology Drawing C04-105C Sheet 1 of 2

28-Lead Plastic Quad Flat, No Lead Package (ML) – 6x6 mm Body [QFN] with 0.55 mm Contact Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.65 BSC	
Optional Center Pad Width	W2			4.25
Optional Center Pad Length	T2			4.25
Contact Pad Spacing	C1		5.70	
Contact Pad Spacing	C2		5.70	
Contact Pad Width (X28)	X1			0.37
Contact Pad Length (X28)	Y1			1.00
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2105A